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FSA2567 — Low-Power, Dual SIM Card Analog Switch

Features

- Low On Capacitance for Data Path: 10 pF Typical
- Low On Resistance for Data Path: 6 Ω Typical
- Low On Resistance for Supply Path: 0.4 Ω Typical
- Wide V_{CC} Operating Range: 1.65 V to 4.3 V
- Low Pow er Consumption: 1 µA Maximum
 - 15 μA Maximum I_{CCT} Over Expanded Voltage Range (V_{IN}=1.8 V, V_{CC}=4.3 V)
- Wide -3 db Bandw idth: > 160 MHz
- Packaged in:
 - Pb-free 16-Lead MLP & 16-Lead UMLP
- 3 kV ESD Rating, >12 kV Pow er/GND ESD Rating

Applications

- Cell phone, PDA, Digital Camera, and Notebook
- LCD Monitor, TV, and Set-Top Box

Description

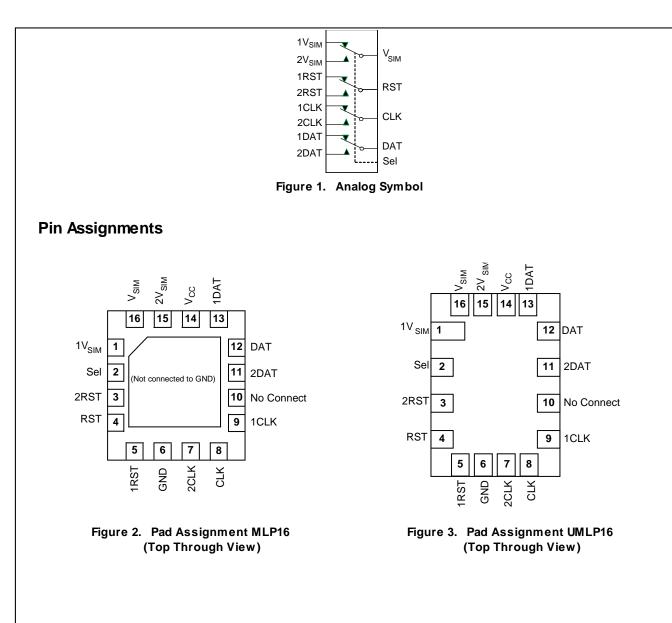
The FSA2567 is a bi-directional, low -pow er, dual doublepole, double-throw (4PDT) analog switch targeted at dual SIM card multiplexing. It is optimized for switching the WLAN-SIM data and control signals and dedicates one channel as a supply-source switch.

The FSA2567 is compatible with the requirements of SIM cards and features a low on capacitance (C_{ON}) of 10 pF to ensure high-speed data transfer. The V_{SIM} sw itch path has a low R_{ON} characteristic to ensure minimal voltage drop in the dual SIM card supply paths.

The FSA2567 contains special circuitry that minimizes current consumption when the control voltage applied to the SEL pin is low er than the supply voltage (V_{CC}). This feature is especially valuable in ultra-portable applications, such as cell phones; allowing direct interface with the general-purpose *l*/Os of the baseband processor. Other applications include switching and connector sharing in portable cell phones, PDAs, digital cameras, printers, and notebook computers.

Ordering Information

Part Number	Top Mark	Operating Temperature Range	Package
FSA2567MPX	FSA2567	-40 to +85°C	16-Lead, Molded Leadless Package (MLP) Quad, JEDEC MO- 220, 3 mm Square
FSA2567UMX	GX		16-Lead, Quad, Ultrathin Molded Leadless Package (UMLP), 1.8 x 2.6 mm



Pin Definitions

Pin	Description
nDAT, nRST, nCLK	Multiplexed Data Source Inputs
nV _{SIM}	Multiplexed SIM Supply Inputs
V _{SIM} , DAT, RST, CLK	Common SIM Ports
Sel	Sw itch Select

Truth Table

Sel	Function
Logic LOW	1DAT = DAT, 1RST = RST, 1CLK = CLK, $1V_{SIM} = V_{SIM}$
Logic HIGH	2DAT = DAT, 2RST = RST, 2CLK = CLK, $2V_{SIM} = V_{SIM}$

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit	
V _{cc}	Supply Voltage		-0.5	+5.5	V
V _{CNTRL}	DC Input Voltage (Sel) ⁽¹⁾		-0.5	V _{cc}	V
V _{SW}	DC Sw itch I/O Voltage ⁽¹⁾		-0.5	$V_{CC} + 0.3$	V
I _{IK}	DC Input Diode Current		-50		mA
I _{SIM}	DC Output Current - V _{SIM}			350	mA
I _{OUT}	DC Output Current – DAT, CLK, RST			35	mA
T _{STG}	Storage Temperature		-65	+150	°C
	Human Body Model, JEDEC: JESD22-A114	All Pins		3	
ESD		I/O to GND		12	kV
	Charged Device Model, JEDEC: JESD22-C101		2		

Note:

1. The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. ON Semiconductor does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
V _{cc}	Supply Voltage	1.65	4.30	V
V _{CNTRL}	Control Input Voltage (Sel) ⁽²⁾	0	V _{cc}	V
V _{SW}	Sw itch VO Voltage	-0.5	V _{cc}	V
I _{SIM}	DC Output Current - V _{SIM}		150	mA
lout	DC Output Current – DAT, CLK, RST		25	mA
T _A	Operating Temperature	-40	+85	°C

Note:

2. The control input must be held HIGH or LOW; it must not float.

DC Electrical Characteristics

All typical values are at 25°C, 3.3 V V_{CC} unless otherwise specified.

Symbol	Parameter	Conditions	V _{cc} (V)	T _A =- 40°C to +85°C			
				Min.	Тур.	Max.	Units
V _{IK}	Clamp Diode Voltage	l _{IN} = -18 mA	2.7			-1.2	V
			1.65 to 2.3	1.1			V
V _{IH}	Input Voltage High		2.7 to 3.6	1.3			
			4.3	1.7			
			1.65 to 2.3			0.4	
V _{IL}	Input Voltage Low		2.7 to 3.6			0.5	V
			4.3			0.7	
I _{IN}	Control Input Leakage	$V_{SW} = 0$ to V_{CC}	4.3	-1		1	μA
Inc(off), Ino(off),	Off State Leakage	nRST, nDAT, nCLK, nV _{SIM} = 0.3 V or 3.6 V Figure 10	4.3	-60		60	nA
	Data Path Switch On Resistance ⁽³⁾	V _{SW} = 0, 1.8 V, I _{ON} = -20 mA Figure 9	1.8		7.0	12.0	Ω
		V_{SW} = 0, 2.3 V, I_{ON} = -20 mA Figure 9	2.7		6.0	10.0	
R _{onv}	V _{SIM} Sw itch On Resistance ⁽³⁾	$V_{SW} = 0, 1.8V, I_{ON} = -100$ mA Figure 9	1.8		0.5	0.7	Ω
		V_{SW} = 0, 2.3 V, I_{ON} = -100 mA Figure 9	2.7		0.4	0.6	
ΔR_{OND}	Data Path Delta On Resistance ⁽⁴⁾	$V_{SW} = 0 V, I_{ON} = -20 mA$	2.7		0.2		Ω
I _{cc}	Quiescent Supply Current	$V_{CNTRL} = 0 \text{ or } V_{CC}, I_{OUT} = 0$	4.3			1.0	μA
I _{CCT}	Increase in I_{CC} Current Per Control Voltage and V_{CC}	$V_{CNTRL} = 2.6 V, V_{CC} = 4.3 V$	4.3		5.0	10.0	μA
		$V_{CNTRL} = 1.8 V, V_{CC} = 4.3 V$	4.3		7.0	15.0	μA

Notes:

3. Measured by the voltage drop betw een nDAT, nRST, nCLK and relative common port pins at the indicated current through the sw itch. On resistance is determined by the low er of the voltage on the relative ports.

4. Guaranteed by characterization.

AC Electrical Characteristics

All typical value are for V_{CC}=3.3V at 25°C unless otherwise specified.

Symbol	Parameter	Conditions	V _{cc} (V)	T _A =- 40°C to +85°C			
				Min.	Тур.	Max.	Units
	Turn-On Time Sel to Output	$R_L = 50 \Omega, C_L = 35 pF$ V _{SW} = 1.5 V	1.8 ⁽⁵⁾		65	95	ns
t _{OND}	(DAT,CLK,RST)	Figure 11, Figure 12	2.7 to 3.6		42	60	ns
t _{OFFD}	Turn-Off Time Sel to Output	R _L = 50 Ω, C _L = 35 pF V _{SW} = 1.5 V	1.8 ⁽⁵⁾		30	50	ns
VOFFD	(DAT,CLK,RST)	Figure 11, Figure 12	2.7 to 3.6		20	40	ns
+	Turn-On Time	$R_L = 50 \Omega, C_L = 35 pF$ V _{SW} = 1.5 V	1.8 ⁽⁵⁾		55	80	ns
t _{onv}	Sel to Output (V_{SIM})	Figure 11, Figure 12	2.7 to 3.6		35	55	ns
t _{OFFV}	Turn-Off Time Sel to Output (V _{SIM})	$R_L = 50 \Omega$, $C_L = 35 pF$ V _{SW} = 1.5 V Figure 11, Figure 12	1.8 ⁽⁵⁾		35	50	
			2.7 to 3.6		22	40	ns
t _{PD}	Propagation Delay ⁽⁵⁾ (DAT,CLK,RST)	$C_L = 35 \text{ pF}, R_L = 50 \Omega$ Figure 11, Figure 13	3.3		0.25		ns
t _{BBMD}	Break-Before-Make ⁽⁵⁾ (DAT,CLK,RST)	$R_L = 50 \Omega$, $C_L = 35 pF$ $V_{SW1} = V_{SW2} = 1.5 V$ Figure 15	2.7 to 3.6	3	18		ns
t _{BBMV}	Break-Before-Make ⁽⁵⁾ (V _{SIM})	$\label{eq:RL} \begin{array}{l} R_{L} = 50 \ \Omega, \ C_{L} = 35 \ pF \\ V_{SW1} = V_{SW2} = 1.5 \ V \\ \textbf{Figure 15} \end{array}$	2.7 to 3.6	3	12		ns
Q	Charge Injection (DAT,CLK,RST)	$\begin{array}{l} C_{\text{L}}=50 \text{ pF}, R_{\text{GEN}}=0 \Omega, \\ V_{\text{GEN}}=0 V \end{array}$	2.7 to 3.6		10		рС
O _{IRR}	Off Isolation (DAT,CLK,RST)	$R_L = 50 \Omega$, f = 10 MHz Figure 17	2.7 to 3.6		-60		dB
Xtalk	Non-Adjacent Channel Crosstalk (DAT,CLK,RST)	$R_L = 50 \Omega$, f = 10 MHz Figure 18	2.7 to 3.6		-60		dB
BW	-3 db Bandwidth (DAT,CLK,RST)	$R_L = 50 \Omega$, $C_L = 5 pF$ Figure 16	2.7 to 3.6		475		MHz

Note:

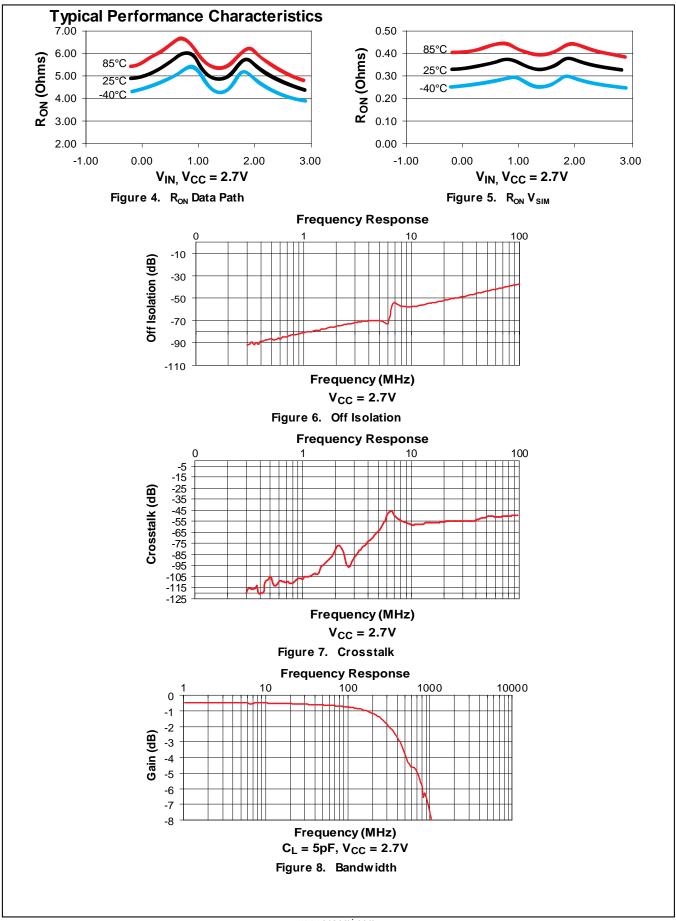
5. Guaranteed by characterization.

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Low-Power, Dual SIM Card Analog Switch
Switch

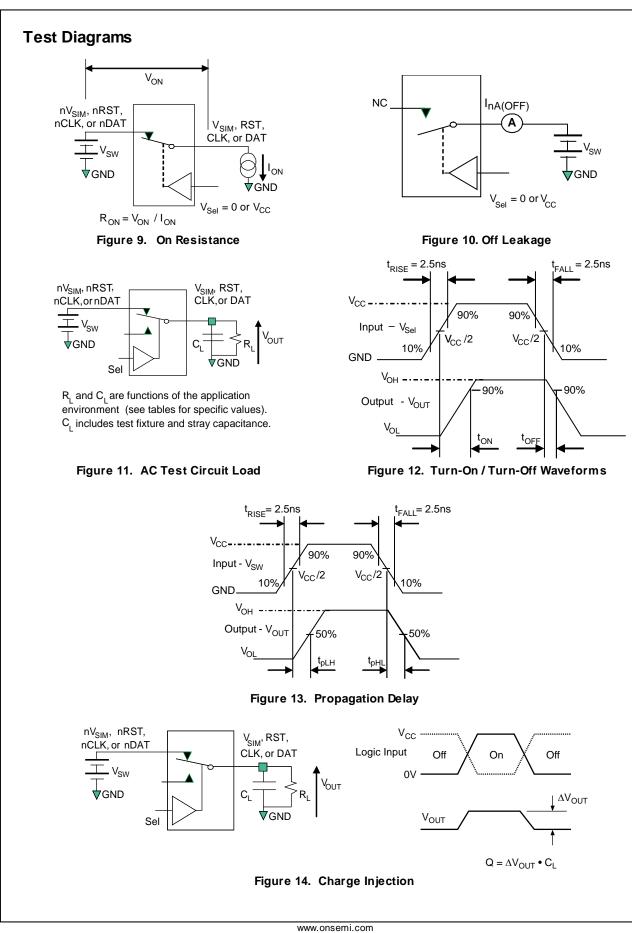
Capacitance T_A=- 40°C to +85°C Units Symbol Conditions Parameter Min. Тур. Max. Control Pin Input Capacitance $V_{CC} = 0 V$ CIN 1.5 $V_{CC}\,{=}\,3.3~V,\,f\,{=}\,1~M\!H\!z$ RST, CLK, DAT On Capacitance⁽⁶⁾ \mathbf{C}_{OND} 10 12 Figure 20 pF V_{CC} = 3.3 V, f = 1 MHz V_{SIM} On Capacitance⁽⁶⁾ 110 150 C_{ONV} Figure 20 V_{cc} = 3.3 V, Figure 19 C_{OFFD} RST, CLK, DAT Off Capacitance 3 $V_{CC} = 3.3 \text{ V}$, Figure 19 40 COFFV V_{SIM} Off Capacitance

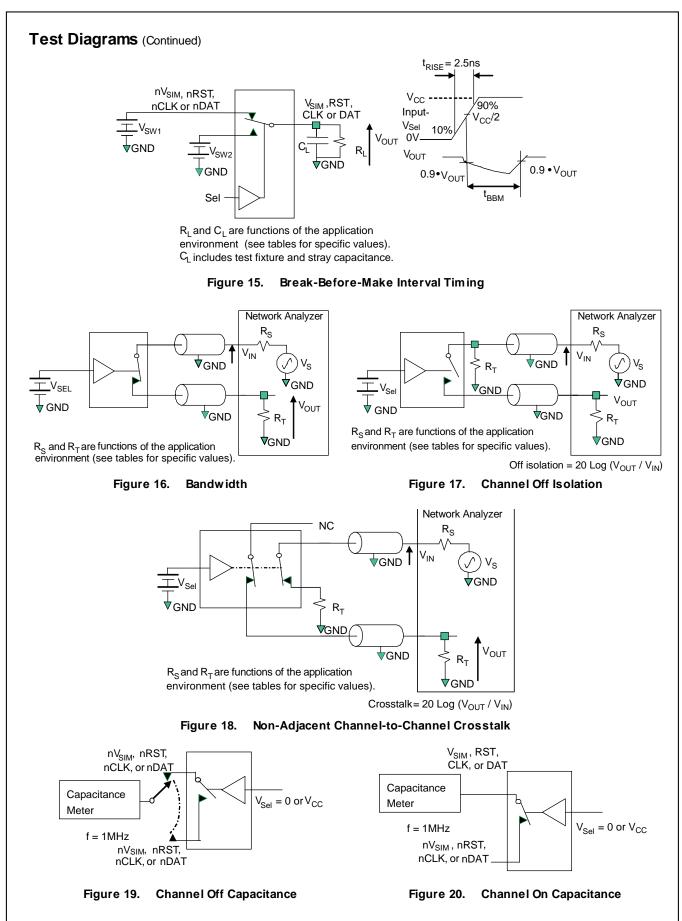
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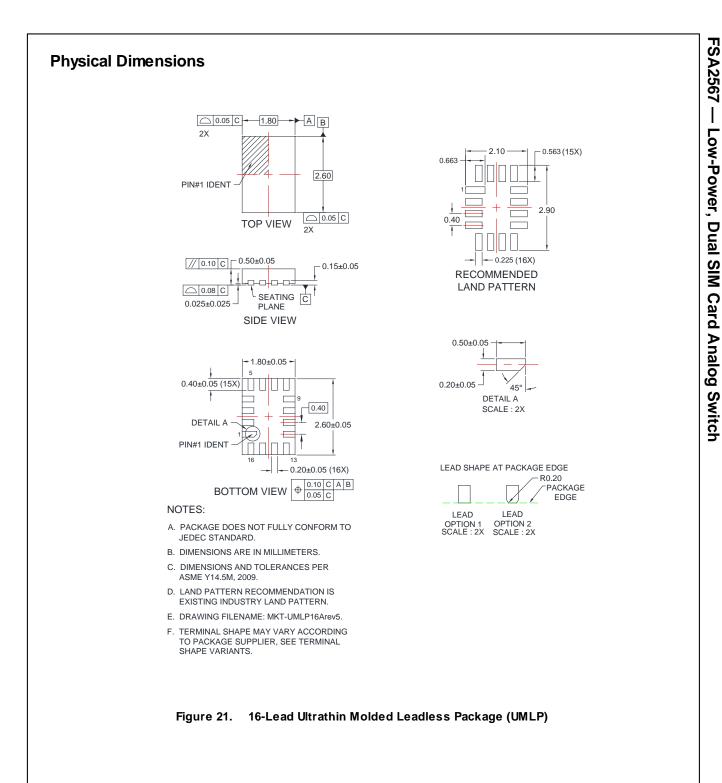
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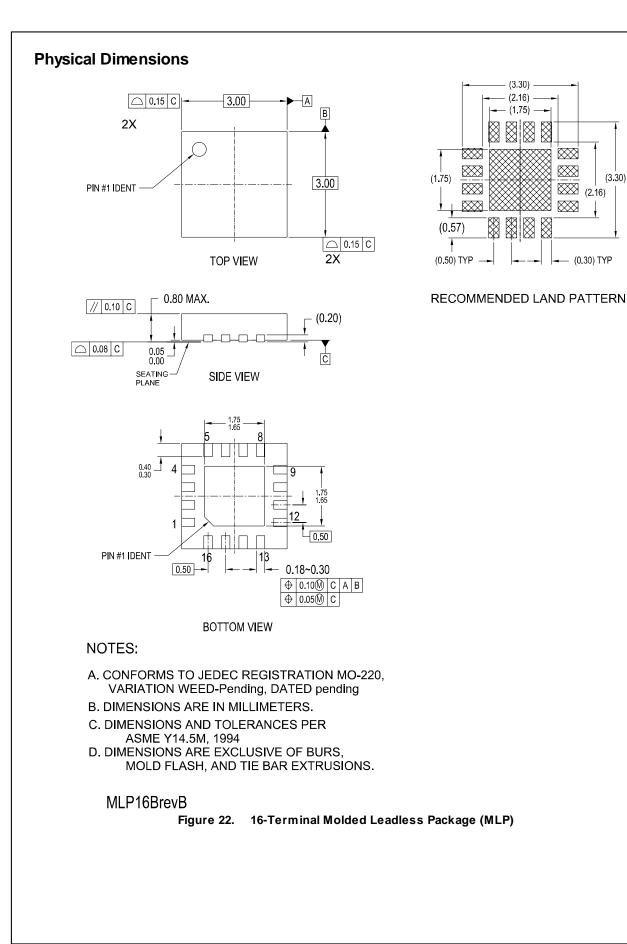


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